

0.5Ω Low Voltage Quad SPDT Analog Switch

General Description

The LN3699 is a quad, low on-resistance, low voltage, bidirectional, single-pole/double-throw (SPDT) CMOS analog switch that is designed to operate from a single +1.8V to +4.2V power supply. Targeted applications include battery powered equipment that benefit from low RON (0.5Ω) and fast switching speeds ($t_{ON} = 52ns$, $t_{OFF} = 25ns$).

The LN3699 consists of four SPDT switches. It is configured as a dual double-pole/double-throw (DPDT) device with two logic control inputs that control two SPDT switches each. The configuration can be used as a dual differential 2-to-1 multiplexer/demultiplexer.

LN3699 is available in a QFN3×3-16 package.

Features

- Voltage range: 1.8V ~ 4.2V
- Low resistance: 0.5Ω (TYP)
- Fast switching time (4.2V): $t_{ON} = 50ns$, $t_{OFF} = 25ns$
- -3dB bandwidth: 70MHz
- Low power consumption: $<0.01\mu W$
- Rail to rail scope of work
- TTL / CMOS compatible
- Small size package: QFN3 × 3-16L

Applications

- Battery-powered, hand-held and portable devices
- Mobile / cell phones
- Laptop notebook, handheld PDA
- Communication system, the user switch
- Medical equipment, ultrasound, ECG
- Test equipment, portable instrumentation, digital multimeter
- Audio and video transmission, conversion
- Sample and hold circuit
- Digital filter
- High-speed multiplexer
- Integral reset circuit

Package

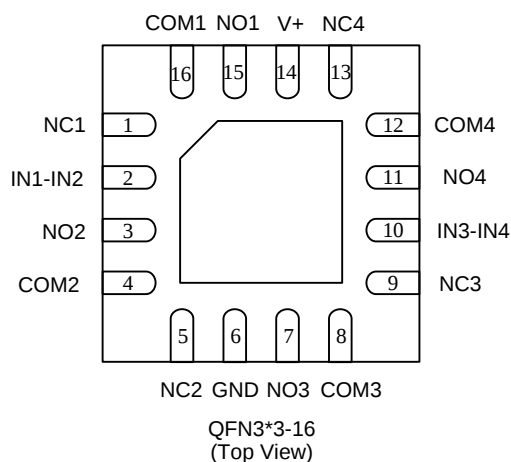
- QFNWB3×3-16L

Ordering Information

LN3699 ①②

Designator	Symbol	Description
①	Q	QFN3×3-16
	X	Others
②	R	Embossed Tape :Standard Feed
	L	Embossed Tape :Reverse Feed

Pin Configuration



Pin Assignment

Pin Name	Pin Number	Function Description
V+	14	Power Supply
GND	6	Ground
IN1-IN2, IN3-IN4	2, 10	Digital control pin to connect the COM terminal to the NO or NC terminals
COM1, COM2 COM3, COM4	16, 4, 8, 12	Common terminal
NO1, NO2, NO3, NO4	15, 3, 7, 11	Normally-open terminal
NC1, NC2, NC3, NC4	1, 5, 9, 13	Normally-closed terminal

Absolute Maximum Ratings

V+ to GND	-0.3V to 5V
Analog, digital voltage range	-0.3V to V ₊ +0.3V
Continuous current NO, NC, COM	±200mA
Peak current NO, NC, or COM	±350mA
Operating temperature Range	-40℃~85℃
Junction temperature	150℃
Storage temperature	-65℃~150℃
Lead temperature (soldering, 10s)	+260℃
ESD(HBM)	4000V

■ Electrical Characteristics

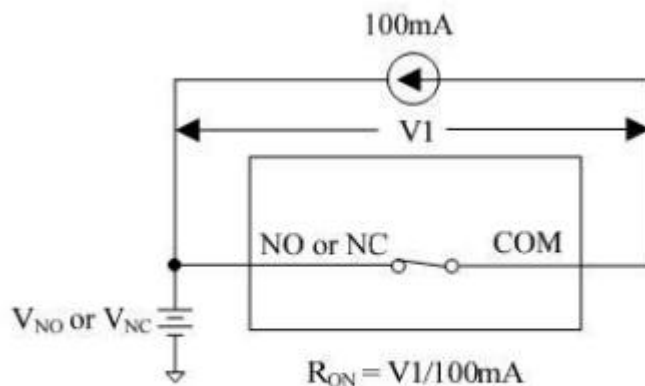
(V+ = +4.2 V ± 10%, GND = 0 V, TA = - 40°C to 85°C, unless otherwise noted. Typical values are at TA = + 25°C.)

Parameter	Symbol	Conditions	+25°C	-40°C~+125°C	Max/Min	Unit
Analog signal range	V _{COM} V _{NC} , V _{NO}			0	MIN	V
				V+	MAX	V
On-resistance	R _{ON}	V _{NO} or V _{NC} =1V, V+=4.2V I _{COM} =-10mA, TEST Circuit 1	0.5		TYP	Ω
			0.75	0.85	MAX	Ω
On-resistance match between channels	ΔR _{ON}	V _{NO} or V _{NC} =1V, V+=4.2V I _{COM} =-10mA, TEST Circuit 1	0.05	0.1	TYP	Ω
			0.15	0.2	MAX	Ω
On-resistance flatness	R _{FLAT (ON)}	V _{NO} or V _{NC} =1V, V+=4.2V I _{COM} =-10mA, TEST Circuit 1	0.1		TYP	Ω
			0.22	0.26	MAX	Ω
Source OFF leakage current	I _{NC(OFF)} I _{NO(OFF)}	V _{NO} or V _{NC} =3.3V/0.3V, V+=4.2V, V _{COM} =0.3V/3.3V	±4		TYP	nA
			±10	±1000	MAX	nA
Channel ON leakage current	I _{NC(ON)} I _{NO(ON)} I _{COM(ON)}	V _{NO} or V _{NC} =V _{COM} =0.3V/3.3V V+=4.2V	±4		TYP	nA
			±10	±1000	MAX	nA
Input high voltage	V _{INH}			1.6	MIN	V
Input low voltage	V _{INL}			0.5	MAX	V
Input current	I _{INH} or I _{INL}	V _{IN} =V _{INH} or V _{INL}	±0.01		TYP	μA
			±1000	±1000	MAX	μA
Turn-on time	t _{ON}	V _{NO} or V _{NC} =2V, R _L =50Ω, C _L =35pF, Test Circuit 2	50		TYP	ns
Turn-off time	t _{OFF}	V _{NO} or V _{NC} =2V, R _L =50Ω, C _L =35pF, Test Circuit 2	25		TYP	ns
Bandwidth-3dB	BW	R _L =50Ω, C _L =5pF, Test Circuit 5	70		TYP	MHz
Channel on capacitance	C _{NC(ON)} C _{NO(ON)} C _{COM(ON)}	f=1MHz	80		TYP	pF
Power supply current	I ₊	V+ =4.2V, V _{IN} =0V or V+	0.001		TYP	μA
			0.1	1	MAX	μA

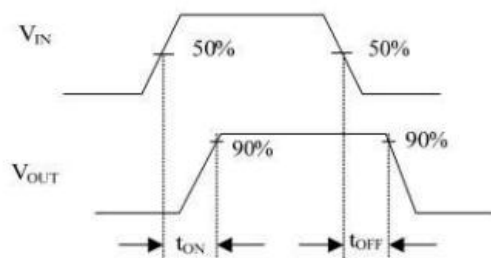
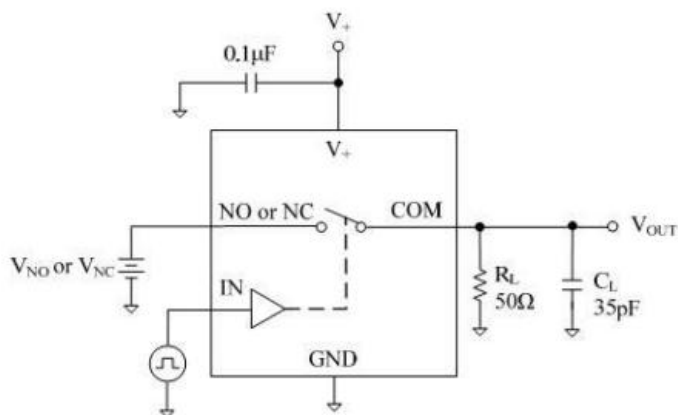
(V+ =2.7V~3.6V, GND = 0 V, TA = - 40°C to +85°C, unless otherwise noted. Typical values are at TA = + 25°C,V+=3V)

Parameter	Symbol	Conditions	+25°C	-40°C~+125°C	Max/Min	Unit
Analog signal range	V _{COM} V _{NC} , V _{NO}			0	MIN	V
				V+	MAX	V
On-resistance	R _{ON}	V _{NO} or V _N =1V,V+=2.7V I _{COM} =-100mA,TEST Circuit 1	0.6		TYP	Ω
			0.9	1.0	MAX	Ω
On-resistance match between channels	ΔR _{ON}	V _{NO} or V _N =1V,V+=2.7V I _{COM} =-100mA,TEST Circuit 1	0.15	0.15	TYP	Ω
			0.2	0.24	MAX	Ω
On-resistance flatness	R _{FLAT (ON)}	V _{NO} or V _N =1V/2.5V,V+=2.7V I _{COM} =-100mA,TEST Circuit 1	0.05	0.1	TYP	Ω
			0.15	0.2	MAX	Ω
Source OFF leakage current	I _{NC(OFF)} I _{NO(OFF)}	V _{NO} or V _{NC} =3.3V/0.3V, V+=3.6V, V _{COM} =0.3V/3.3V	±5		TYP	nA
				±1000	MAX	nA
Channel ON leakage current	I _{NC(ON)} I _{NO(ON)} I _{COM(ON)}	V _{NO} or V _{NC} =0.3V/3.3V, V+=3.6V, V _{COM} =0.3V/3.3V	±5		TYP	nA
				±1000	MAX	nA
Input high voltage	V _{INH}			1.6	MIN	V
Input low voltage	V _{INL}			0.4	MAX	V
Input current	I _{INH} or I _{INL}	V+=2.7V,V _{IN} =2.7V or 0V	±0.01		TYP	μA
				±1	MAX	μA
Turn-on time	t _{ON}	V _{NO} or V _{NC} =2V, R _L =50Ω, C _L =35pF, Test Circuit 2	55		TYP	ns
Turn-off time	t _{OFF}	V _{NO} or V _{NC} =2V, R _L =50Ω, C _L =35pF, Test Circuit 2	35		TYP	ns
Bandwidth-3dB	BW	C _L =5pF, Test Circuit 3	70		TYP	MHz
Channel on capacitance	C _{NC(ON)} C _{NO(ON)} C _{COM(ON)}		80		TYP	pF
Power supply current	I ₊	V+ =3.3V,V _{IN} =0V or V+	0.001		TYP	μA
				1	MAX	μA

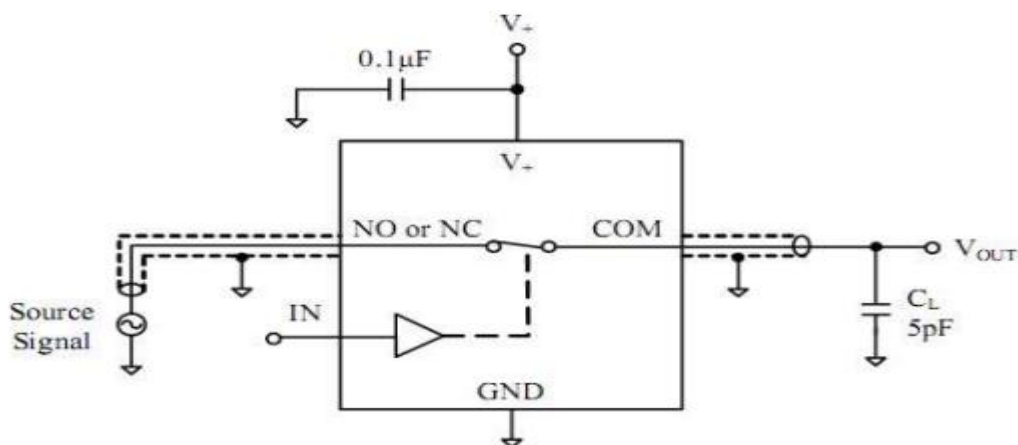
■ Test Circuits



Test Circuit 1. On Resistance



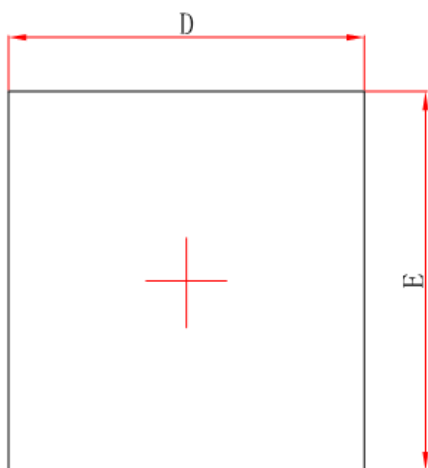
Test Circuit 2. Switching Times



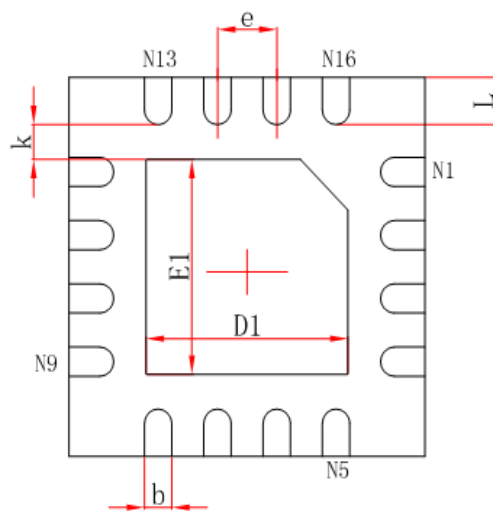
Test Circuit 3. -3dB Bandwidth

Package Information

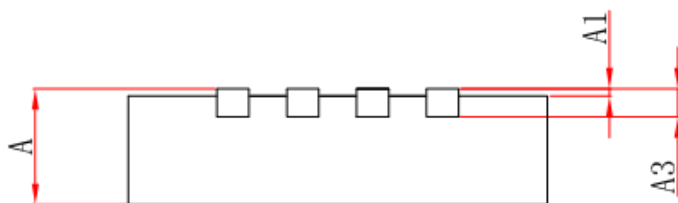
DFN3×3-16L



Top View



Bottom View



Side View

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700/0.800	0.800/0.900	0.028/0.031	0.031/0.035
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	2.900	3.100	0.114	0.122
E	2.900	3.100	0.114	0.122
D1	1.600	1.800	0.063	0.071
E1	1.600	1.800	0.063	0.071
k	0.200MIN.		0.008MIN.	
b	0.180	0.300	0.007	0.012
e	0.500TYP.		0.020TYP.	
L	0.300	0.500	0.012	0.020